

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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Email & Skype: info@chipsmall.com Web: www.chipsmall.com

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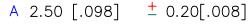




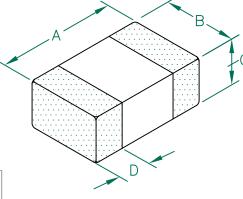
CPI1008K1R8R-10

UNCONTROLLED DOCUMENT

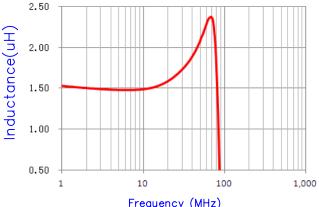
PHYSICAL DIMENSIONS:



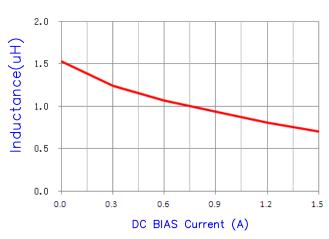
- B 2.00 [.079] ± 0.20[.008]
- $^{\circ}$ 0.90 [.035] $^{\pm}$ 0.10[.004]
- D 0.60 [.024] ± 0.20[.008]



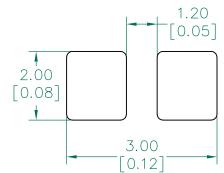




Ls vs DC BIAS Current







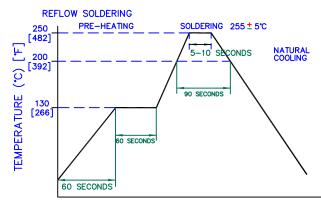
(For wave soldering. add 0.763 [0.030] to this dimension)

ELECTRICAL CHARACTERISTICS:										
	L (μΗ) @ 1MHz ± 20%	DCR (Ω) ± 25%	l (Max)							
Nom	1.80	0.1300								
Min	1.44	0.0975								
Max	2.16	0.1625	1500mA							

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL, EMBOSSED PLASTIC TAPE.
- 2. TERMINATION FINISH IS 100% MATTE Sn OVER Ni.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. I (MAX.) IS BASED ON THE MAXIMUM SUSTAINED CURRENT APPLIED WHILE MAINTAINING A MAXIMUM TEMPERATURE RISE OF 40°C OVER AMBIENT.
- 5. OPERATION TEMPERATURE TEMP: -55°C~+125°C (INCLUDING SELF-HEATING)

RECOMMENDED SOLDERING CONDITIONS





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		DIMENSIONS ARE IN mm [INCHI	This print is the property of Lair	rd						
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Γ					reserved.					
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	С	UPDATE PAD DIMENSION ROHS	07/08/14	QU	CPI1008K1R8R-10		•			40
Γ	В	UPDATE LAIRD LOGO AND NOTES 5	08/05/13	QU	DATE: 03/01/11	SCALI	B N	TS	SHEET:	I .
Γ	Α	ORIGINAL DRAFT	03/01/11	QU	, ,	TOOL		13		
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